IRL620

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

 V_{DS} (V) $R_{DS(on)}$ (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_q (Max.) (nC)

Configuration

Power MOSFET

S

N-Channel MOSFET

0.80

200

16

2.7

9.6

Single

 $V_{GS} = 5.0 V$

FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- Logic-level gate drive
- R_{DS(on)} specified at V_{GS} = 4 V and 5 V
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRL620PbF
Lead (Pb)-free and halogen-free	IRL620PbF-BE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	200	v	
Gate-source voltage			V _{GS}	± 10		
Continuous drain current	V _{GS} at 5 V	T _C = 25 °C		5.2		
		T _C = 100 °C	I _D	3.3	А	
Pulsed drain current ^a	I _{DM}	21				
Linear derating factor				0.40	W/°C	
Single pulse avalanche energy ^b			E _{AS}	125	mJ	
Repetitive avalanche current ^a			I _{AR}	5.2	А	
Repetitive avalanche energy ^a			E _{AR}	5.0	mJ	
Maximum power dissipation	T _C =	25 °C	P _D	P _D 50		
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) ^d	For 10 s			300 ^d		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 6.9 mH, R_g = 25 Ω , I_{AS} = 5.2 A (see fig. 12)

c. $I_{SD} \le 5.2$ A, $dV/dt \le 120$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS												
PARAMETER	SYMBOL	TYP.		MAX.		UNIT						
Maximum junction-to-ambient	R _{thJA}	- 62 0.50 -										
Case-to-sink, flat, greased surface	R _{thCS}			°C/W		°C/W						
Maximum junction-to-case (drain)	R _{thJC}	- 2.5										
	•											
SPECIFICATIONS (T _J = 25 °C, u	Inless otherw	ise noted)										
PARAMETER	SYMBOL	TEST	CONDIT	ONS	MIN.	TYP.	MAX.	UNIT				
Static	•	1					I					
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0	V, I _D = 2	50 µA	200	-	-	V				
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference t	o 25 °C,	I _D = 1 mA	-	0.27	-	V/°C				
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{CS}$	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			-	2.0	V				
Gate-source leakage	I _{GSS}	V	_{GS} = ± 10		-	-	± 100	nA				
7		V _{DS} = 20	V _{DS} = 200 V, V _{GS} = 0 V		-	-	25					
Zero gate voltage drain current	t I_{DSS} $V_{DS} = 160 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 ^{\circ}$, T _J = 125 °C	-	-	250	μA					
Drain-source on-state resistance	5	V _{GS} = 5.0 V	١	_D = 3.1 A ^b	-	-	0.80	Ω				
	R _{DS(on)}	V _{GS} = 4.0 V	١	₀ = 2.6 A ^b	-	-	1.0					
Forward transconductance	9 _{fs}	V _{DS} = 50 V, I _D = 3.1 A ^b			1.2	-	-	S				
Dynamic	•											
Input capacitance	C _{iss}	V	_{GS} = 0 V,		-	360	-					
Output capacitance	C _{oss}	$V_{DS} = 25 V$,		-	91	-	pF					
Reverse transfer capacitance	C _{rss}	f = 1.0 l	MHz, see	e fig. 5	-	27	-	1				
Total gate charge	Qg				-	-	16					
Gate-source charge	Q _{gs}	V _{GS} = 5.0 V	$V_{GS} = 5.0 V$ $I_D = 5.2 A, V_{DS} = 5.0 V$ see fig. 6 an		-	-	2.7	nC				
Gate-drain charge	Q _{gd}				-	-	9.6					
Turn-on delay time	t _{d(on)}				-	4.2	-					
Rise time	t _r	V _{DD} = 100 V, I _D = 9.0 A,			-	31	-	ns				
Turn-off delay time	t _{d(off)}	$R_g = 6.0 \Omega, R_f$	$R_g = 6.0 \ \Omega, R_D = 11 \ \Omega, \text{ see fig. } 10^b$			18	-					
Fall time	t _f					17	-					
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact			-	4.5	-	nH				
Internal source inductance	L _S				-	7.5	-					
Drain-Source Body Diode Characteristi	cs											
Continuous source-drain diode current	I _S	MOSFET symbol showing the		-	-	5.2	A					
Pulsed diode forward current ^a	I _{SM}	p - n junction diode			-	-		21				
Body diode voltage	V _{SD}	$T_J = 25 \ ^\circ C, \ I_S = 5.2 \ A, \ V_{GS} = 0 \ V^b$			-	-	1.8	V				
Body diode reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 5.2 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{b}$			-	180	270	ns				
Body diode reverse recovery charge	Q _{rr}				-	1.1	1.7	μC				
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is dor	minated by L _S and L _D)						

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width $\leq 300~\mu s;~duty~cycle \leq 2~\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

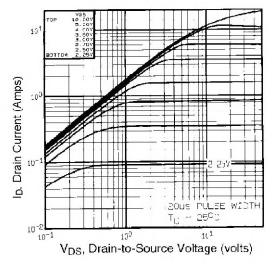


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

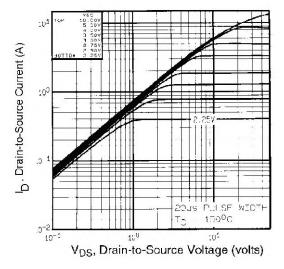


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

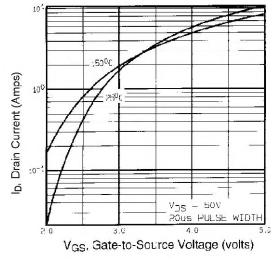


Fig. 3 - Typical Transfer Characteristics

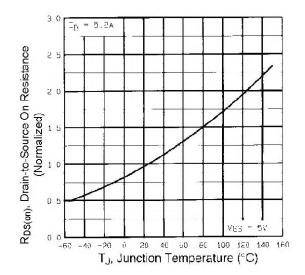


Fig. 4 - Normalized On-Resistance vs. Temperature

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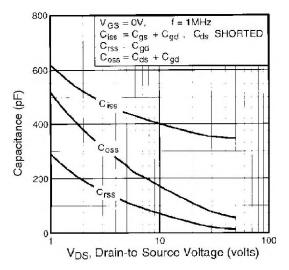


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

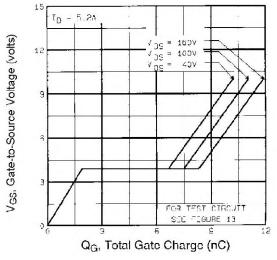


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

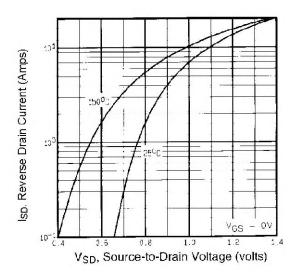


Fig. 7 - Typical Source-Drain Diode Forward Voltage

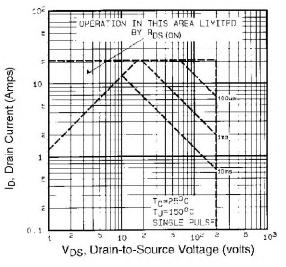


Fig. 8 - Maximum Safe Operating Area

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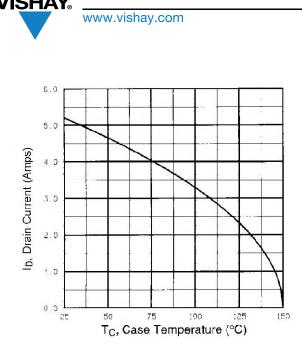


Fig. 9 - Maximum Drain Current vs. Case Temperature

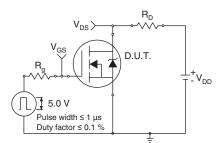


Fig. 10a - Switching Time Test Circuit

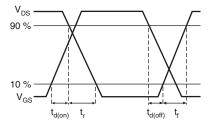


Fig. 10b - Switching Time Waveforms

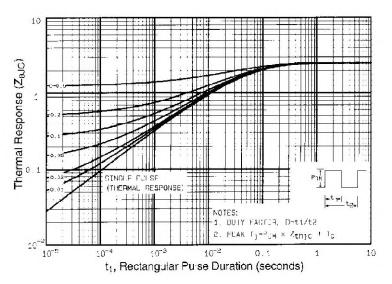


Fig. 10 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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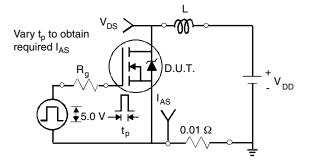


Fig. 12a - Unclamped Inductive Test Circuit

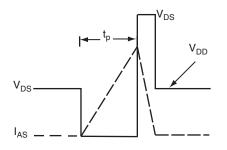


Fig. 12b - Unclamped Inductive Waveforms

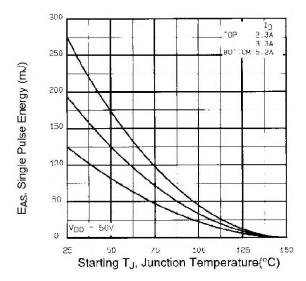


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

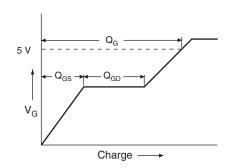


Fig. 13a - Basic Gate Charge Waveform

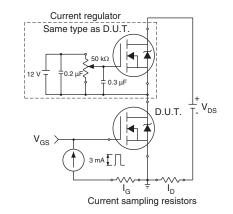


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

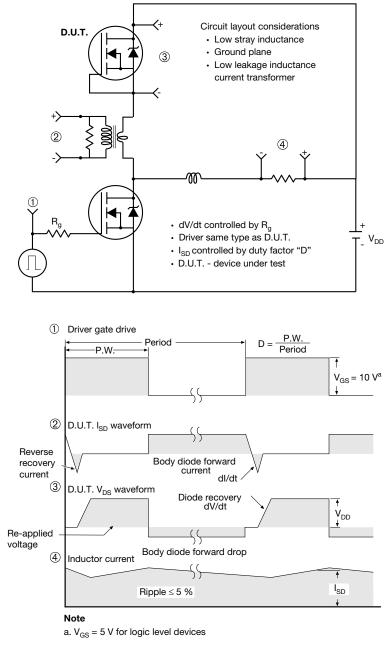


Fig. 11 - For N-Channel

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